- Contains Six Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct Clear Inputs
- Applications Include: Buffer/Storage Registers Shift Registers

Pattern Generators

- Fully Buffered Outputs for Maximum Isolation From External Disturbances
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

(TOP VIEW) CLR 16 V_{CC} 1Q [2 15 **6**Q 3 1D Π 14**∏** 6D 4 13**∏** 5D 2D | 12 1 5Q 2Q 5 11 | 4D 3D 6 10 1 4Q 7 3Q 9 CLK **GND**

D OR N PACKAGE

description

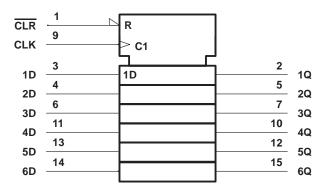
This monolithic, positive-edge-triggered flip-flop utilizes TTL circuitry to implement D-type flip-flop logic with a direct clear (CLR) input. Information at the data (D) inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

The SN74F174A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each flip-flop)

	INPUTS	OUTPUT	
CLR	CLK	D	Q
Н	L	Х	Q ₀
Н	\uparrow	Н	Н
Н	\uparrow	L	L
L	Х	Χ	L

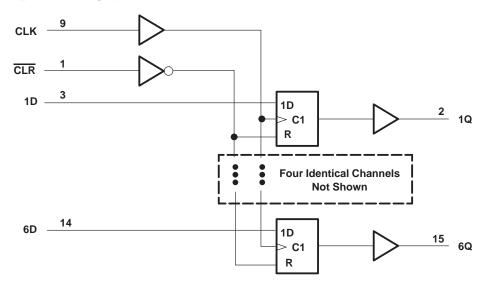
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	1.2 V to 7 V
Input current range	30 mA to 5 mA
Voltage applied to any output in the high state	\dots -0.5 V to V _{CC}
Current into any output in the low state	40 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
liK	Input clamp current			-18	mA
ІОН	High-level output current			-1	mA
l _{OL}	Low-level output current			20	mA
TA	Operating free-air temperature	0		70	°C



NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CON	IDITIONS	MIN	TYP [†]	MAX	UNIT
VIK	$V_{CC} = 4.5 V,$	I _I = – 18 mA			- 1.2	V
Vou	$V_{CC} = 4.5 V,$	$I_{OH} = -1 \text{ mA}$	2.5	3.4		V
Voн	$V_{CC} = 4.75 V,$	$I_{OH} = -1 \text{ mA}$	2.7			V
V _{OL}	$V_{CC} = 4.5 V,$	$I_{OL} = 20 \text{ mA}$		0.3	0.5	V
ΙĮ	$V_{CC} = 5.5 V,$	V _I = 7 V			0.1	mA
lін	$V_{CC} = 5.5 V,$	V _I = 2.7 V			20	μΑ
I _{IL}	$V_{CC} = 5.5 V,$	V _I = 0.5 V			- 0.6	mA
los [‡]	$V_{CC} = 5.5 V,$	VO = 0	- 60		- 150	mA
Іссн	V _{CC} = 5.5 V,	See Note 2		30	45	mA
ICCL	V _{CC} = 5.5 V,	See Note 3		39	55	mA

timing requirements

			V _{CC} =	= 5 V, 25°C	V _{CC} = 4.5 T _A = MIN t	UNIT		
			MIN	MAX	MIN	MAX		
fclock	Clock frequency		0	100	0	80	MHz	
		CLK high	4		4			
t _W	Pulse duration	CLK low	6		6		ns	
		CLR low	5		5			
	Out on the hadened OLKA	Data high or low	4.5		4.5			
t _{su}	Setup time before CLK↑	CLR high¶	5		5		ns	
th	Hold time after CLK↑	Data high or low	0.5		1		ns	

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics (see Note 4)

PARAMETER	FROM TO (OUTPUT)			V_{CC} = 5 V, C_{L} = 50 pF, R_{L} = 500 Ω, T_{A} = 25°C			$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$ $T_A = \text{MIN to MAX} \S$		
			MIN	TYP	MAX	MIN	MAX		
f _{max}			100	140		80		MHz	
^t PLH	CLK	Any Q	2.7	4.5	8	2.7	9	ns	
^t PHL	CLK	Ally Q	3.4	4.2	10	3.3	11	115	
^t PHL	CLR	Any Q	4.2	6.3	14	4.2	15	ns	

NOTE 4: Load circuits and waveforms are shown in Section 1.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTES: 2. I_{CCH} is measured with all outputs open, all data inputs and enable input at 4.5 V, and the clock input at 4.5 V after being momentarily

^{3.} ICCL is measured with all outputs open, all data inputs and enable input at 0 V, and the clock input at 4.5 V after being momentarily grounded.

 $[\]P$ Inactive-state setup time is also referred to as recovery time.

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN74F174AD	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	0 to 70	F174A
SN74F174ADR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F174A
SN74F174ADR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F174A
SN74F174ADRE4	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F174A
SN74F174AN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F174AN
SN74F174AN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F174AN

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F174ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74F174ADR	SOIC	D	16	2500	353.0	353.0	32.0	

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74F174AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74F174AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74F174AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74F174AN.A	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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